

Data Sheet

Cusiltin™ 10 (AMS 4773)

Description:

High-purity silver, copper and tin alloy for vacuum brazing.

Nominal composition by weight: **60% Ag, 30% Cu and 10% Sn**

Prime features:

- Lower melting version of Cusiltin 5

Physical Properties*

Liquidus Temperature	718 °C 1325 °F
Solidus Temperature	602 °C 1115 °F
Coefficient of Thermal Expansion (CTE)	
Thermal Conductivity (Calculated)	30 x 10 ⁻⁶ /C, for 20 – 500 °C 17.5 x 10 ⁻⁶ /°F, for 68 – 932 °F
Density	9.75 Mg/m ³ 0.352 lb/in ³
Yield Strength (0.2% offset)	358 MPa 51.9 x 10 ³ lb/in ²
Tensile Strength	462 MPa 67.1 x 10 ³ lb/in ²
Elongation (2in/50mm gage section)	38%
Electrical Resistivity	247 x 10 ⁻⁹ ohm·m
Electrical Conductivity	4.0 x 10 ⁶ /ohm·m
Vapor Pressure (Calculated)	
Recommended Brazing Temperatures	718 – 843 °C
Recommended Brazing Atmospheres	10 ⁻⁵ mm Hg, H ₂ , or inert gas

* Please note that all values quoted are based on test pieces and may vary according to component design. These values are not guaranteed in any way and should only be treated as indicative values. They should be used for guidance only and for no other purpose whatsoever.

Impurity Limits

Zn	less than 0.001%
Cd	less than 0.001%
Pb	less than 0.002%
P	less than 0.002%
C	less than 0.01%

All other metallic impurities having a vapor pressure higher than 10⁻⁷ mm Hg at 500 °C are limited to 0.002% each. Impurities having a vapor pressure lower than 10⁻⁷ mm Hg at 500 °C are limited to a total of 0.075%. (This applies to all forms except powder and extrudable paste.)

Supplied as:

- Foil
- Wire
- Powder
- Extrudable paste
- Preforms

The determination as to the adaptability of any Wesgo materials to the specific needs of the Buyer is solely the Buyer's prerogative and responsibility. All technical information, data and recommendations are based on tests and accumulated experience data, which Wesgo believed to be reliable. However, the accuracy and completeness thereof are not guaranteed.

